

KBJ1006G THRU KBJ1010G

General Bridge Rectifiers



Voltage: 600~1000 Volts

Current: 10.0 Amperes

Package: KBJ

Features

- NH'S Standard Rectifier Chip Technology
- Low Forward Voltage Drop For High Efficiency
- Low Leakage Current For High Reliability
- High Surge Capability For High Reliability

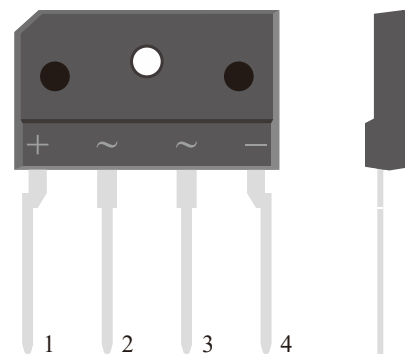
Mechanical Data

- **Case:** Molded With UL-94 ClassV-0 Recognized, RoHS-Compliant
- **Polarity:** Look At The Diagram And Polarity On The Right
- **Terminals:** Tin Plated Leads,Solderable Per J-STD-002 And JESD22-B102

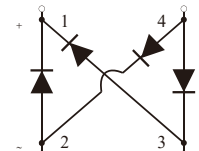
Typical Applications

- Switch Mode Power Supplies (SMPS)
- Fast Chargers
- LED Driver And Monitor Lighting
- Automotive Electronics And Charging Posts

Diagram:



Polarity:



Single Phase,Half Wave,60Hz,Resistive Or Inductive Load.For Capacitive Load,Derate Current By 20%

Maximum Ratings (Ta=25°C Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	KBJ 1006G	KBJ 1008G	KBJ 1010G	Unit
Maximum Repetitive Peak Reverse Voltage		V_{RRM}	600	800	1000	V
Maximum RMS Voltag		V_{RMS}	420	560	700	V
Maximum DC Blocking Voltage		V_{DC}	600	800	1000	V
Maximum Average Forward Rectified Current	With Heatsink 100 °C Without Heatsink 25 °C	$I_{F(AV)}$	10 3			A
Peak Forward Surge Current Per Diode	8.3ms Single Half Sine-wave Superimposed On Rate Load	I_{FSM}	200			A
Current Squared Time Per Diode	$t < 8.3ms$	I^2t	166.0			A ² sec
Maximum Mounting Torque	M3 screw	T_{MM}	1.1			N.m

Electrical Characteristics (Ta=25°C Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	KBJ 1006G	KBJ 1008G	KBJ 1010G	Unit
Instantaneous Forward Voltage Per Diode	$I_F = 5.0 A$	V_F	1.0			V
Maximum DC Reverse Current at Rated DC Blocking Voltage	Ta=25°C , $V_R = V_{RRM}$ Ta=125°C , $V_R = V_{RRM} * 80\%$	I_{RRM}	5 500			uA
Typical Junction Capacitance Per Diode	4 V,1MHz	C_J	70			pF

Thermal Characteristics (Ta=25°C Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	KBJ 1006G	KBJ 1008G	KBJ 1010G	Unit
Operating Junction Temperature Range		T _J	-55~150			℃
Storage Temperature Range		T _{STD}	-55~150			
Thermal Resistance Junction To Ambient With Steady-State	Still Air Environment With Ta=25℃	R _{θJA}	28.0			℃/W
Thermal Resistance Junction-Case With Steady-State	Device Mounted On 75mm x 45mm x 2.5mm Alu. Heat.	R _{θJC}	3.5			

Notes: 1.Pulse Test: 300 Us Pulse Width,1% Duty Cycle

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Typical Characteristics Curves

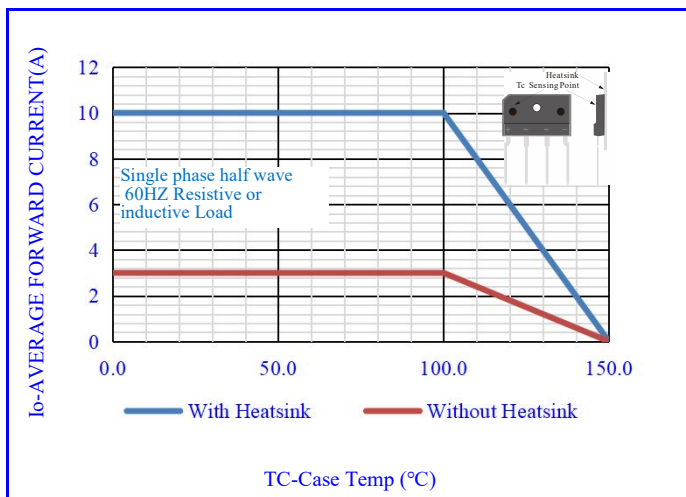


Fig.1-FORWARD CURRENT DERATING CURVE

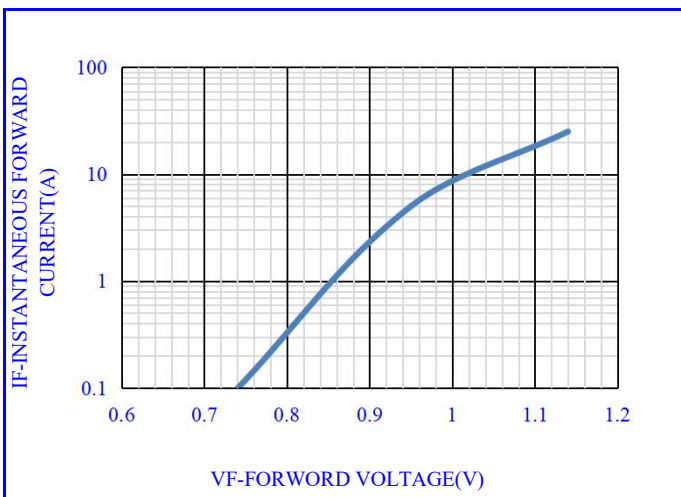


Fig.2- TYPICAL INSTANTANEOUS FORWARD

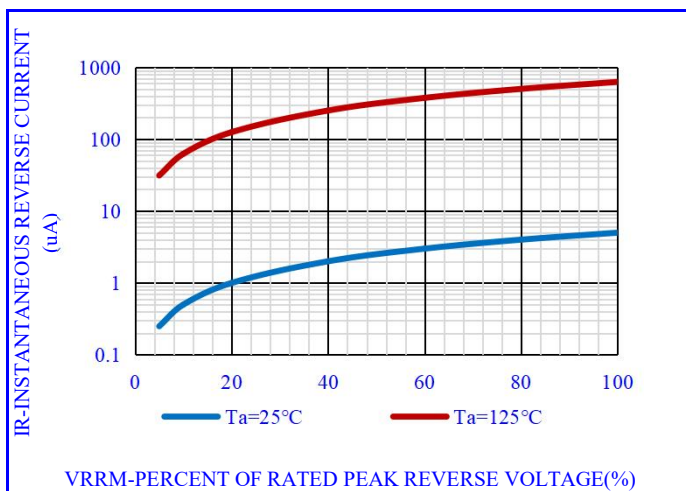


Fig.3- TYPICAL REVERSE CHARACTERISTICS

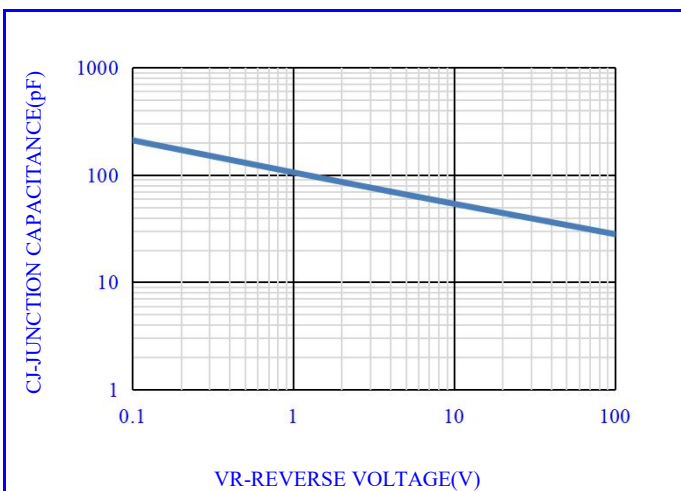


Fig.4- TYPICAL JUNCTION CAPACITANCE

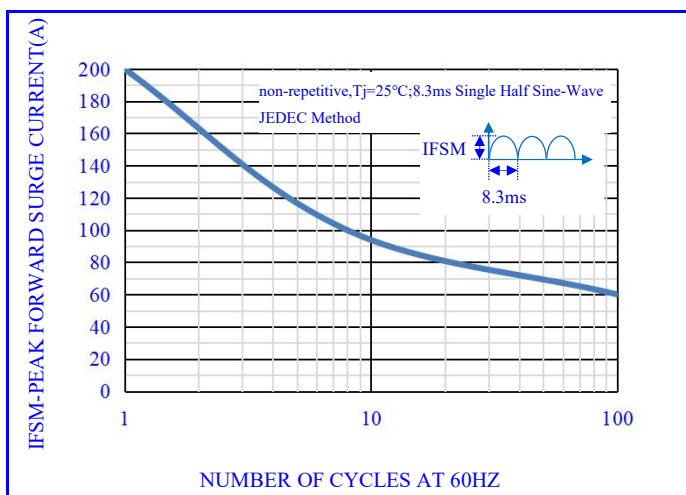
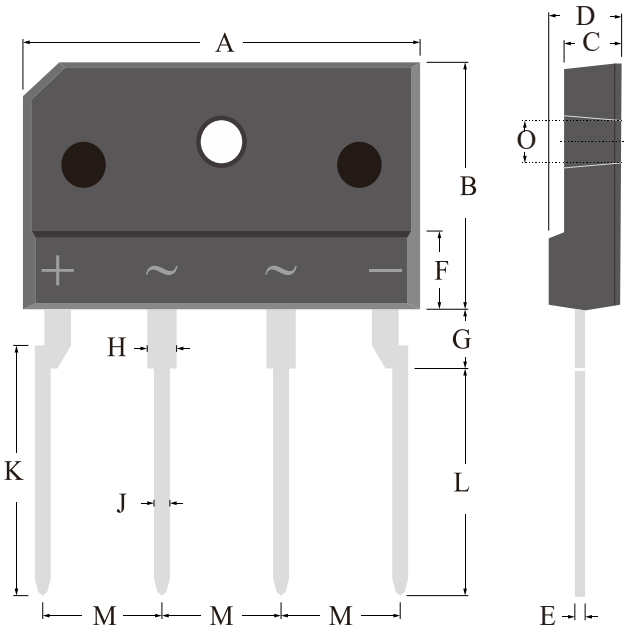


Fig.5-MAX. NON-REPETITIVE SURGE CURRENT

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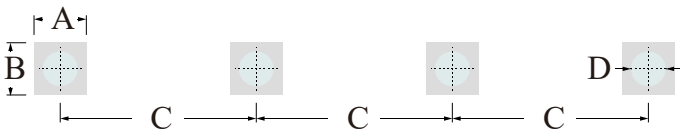
OUTLINE DRAWINGS



KBJ

OUTLINE DIMENSIONS						
Dim.	Milimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	24.00	-	26.00	0.9449	-	1.0236
B	14.00	-	16.00	0.5512	-	0.6299
C	3.30	-	3.90	0.1299	-	0.1535
D	4.20	-	4.80	0.1654	-	0.1890
E	0.40	-	0.80	0.0157	-	0.0315
F	4.50	-	5.00	0.1772	-	0.1969
G	3.40	-	3.80	0.1339	-	0.1496
H	1.60	-	2.00	0.0630	-	0.0787
J	0.85	-	1.15	0.0335	-	0.0453
K	14.00	-	16.00	0.5512	-	0.6299
L	12.70	-	114.70	0.5000	-	4.5157
M	7.25	-	7.75	0.2854	-	0.3051
O	3.00	-	3.40	0.1181	-	0.1339

RECOMMEDND LAYOUT DRAWINGS



KBJ

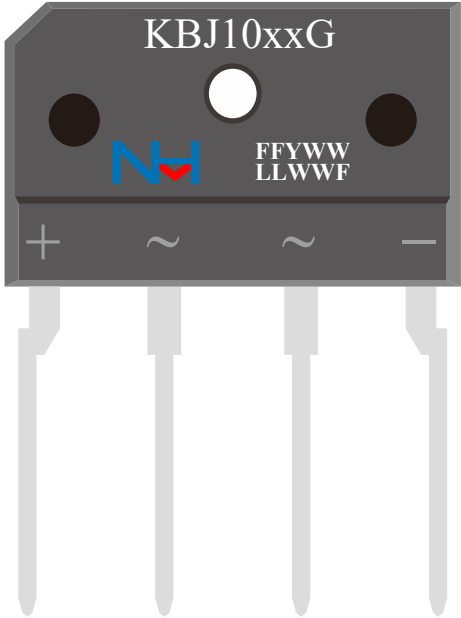
OUTLINE DIMENSIONS						
Dim.	Milimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	-	2.00	-	-	0.0787	-
B	-	2.00	-	-	0.0787	-
C	-	7.50	-	-	0.2953	-
D	-	1.20	-	-	0.0472	-

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MARKING



MARKING INSTRUCTION

NH=Niuhang Trademark
FF=Product Line Code,According To Actual Changes
YWW=Date Code,According To Actual Changes
LLWWF=Inernal Code,According To Actual Changes
KBJ10xxG=Model,xx=06,08,10

PACKING INFORMATION

Package Type	Package Code	Product Weight Approx(g/Pcs)	Package Method	Quantity (Pcs/Min. Pack.)	Quantity (Pcs/Inner Box)	Quantity (Pcs/Carton)
KBJ	P1	4.085	Box	50	1000	5000

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Recommended wave soldering condition

Product	Peak Temperature	Soldering Time
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds

Recommended temperature profile for IR reflow



Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
Average ramp-up rate (T _{smax} to T _p)	3°C/second max.	3°C/second max.
Preheat -Temperature Min(TS min) -Temperature Max(TS max) -Time(ts min to ts max)	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
Time maintained above: -Temperature (TL) - Time (tL)	183°C 60-150 seconds	217°C 60-150 seconds
Peak Temperature(TP)	240 +0/-5 °C	260 +0/-5 °C
Time within 5°C of actual peak temperature(tp)	10-30 seconds	20-40 seconds
Ramp down rate	6°C/second max.	6°C/second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

Note : All temperatures refer to topside of the package, measured on the package body surface.

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